

## xtreme Conventional Positive Offset Plates (CC)

xtreme Conventional Offset Plates can be processed with a wide variety of developer brands for manual as well as automatic processing. The Plates have an excellent resolving power and dot resolution, the vacuum assist surface guarantees an optimum contact. The anodized surface ensures a wide damping latitude with high Ink density and low damp. The Plates have a very good resistance to alcohol and press chemicals.

### Transport & Storage

Store plates flat in their package, away from excessive heat or high humidity, at 20 - 26 °C with RH between 40 - 60%. Settings are indications only and may slightly vary, differences are caused by equipment characteristics, chemistry performance and environmental conditions.

Coating Weight:	2.1 - 2.4 g/m <sup>2</sup>
Anodizer Layer:	2 - 3.5 g/m <sup>2</sup>
Grain Ra:	0.6 - 0.7 µm
Contrast:	>10 D
Resolving Power:	8 - 10 µm
Run length:	100.000~150.000 pcs.
Dot reproduction:	2 - 98%
Exposure:	UV Metal
Exposure quantity:	80 mj/cm <sup>2</sup> (1 meter distance) Refer to HG/T2694-2003 3-step clear of CTP wedge
Developer:	Common PS developers
Temperature:	25° ± 2°C



*The information given in this leaflet is to be considered reliable and is provided in good faith but without guarantee, subject to change without notice.*

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